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| INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99) | Application Number | | 10786596 | |
| | Filing Date | | 2004-02-26 | |
| | First Named Inventor | Daniel Y. Fung | | |
| | Art Unit | 4172 | | |
| | Examiner Name | Wong, Eric Tak Wai | | |
| | Attorney Docket Number | 028635-12 | | |

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| Examiner Initial* | Cite No | Patent Number | Kind Code ¹ | Issue Date | Name of Patentee or Applicant of cited Document | Pages,Columns,Lines where Relevant Passages or Relevant Figures Appear |
| | 1 | 7006993 | B1 | 2006-02-28 | Cheong et al. | |

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| | 3 | 20040230536 | | 2004-11-18 | Fung | |

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| | 1 | 2410746 | CA | | 2001-09-07 | Passgate Corp. (US) | also published as WO0165511 | <input type="checkbox"/> |

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